RoHS

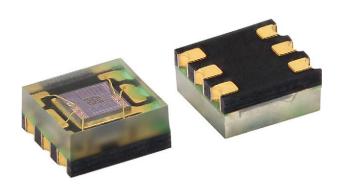
HALOGEN FREE

GREEN



Vishay Semiconductors

High Accuracy Ambient Light Sensor With I²C Interface



DESCRIPTION

VEML6030 is a high accuracy ambient light digital 16-bit resolution sensor in a miniature transparent 2 mm x 2 mm package. It includes a high sensitive photodiode, a low noise amplifier, a 16-bit A/D converter and supports an easy to use I²C bus communication interface and additional interrupt feature.

The ambient light result is as digital value available.

APPLICATIONS

- Ambient light sensor for mobile devices (e.g. smart phones, touch phones, PDA, GPS) for backlight dimming
- Ambient light sensor for industrial on-/off-lighting operation
- Optical switch for consumer, computing, and industrial devices and displays

FEATURES

- Package type: surface-mount
- Dimensions (L x W x H in mm): 2 x 2 x 0.87
- · Integrated modules: ambient light sensor (ALS)
- Supply voltage range V_{DD}: 2.5 V to 3.6 V
- Communication via I²C interface
- I2C bus H-level range: 1.7 V to 3.6 V
- Floor life: 72 h, MSL 4, according to J-STD-020
- Low stand by current consumption: typ. 0.5 μA
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AMBIENT LIGHT FUNCTION

- FiltronTM technology adaption: close to real human eye response
- O-TrimTM technology adoption: ALS output tolerance \leq 10 %
- 16-bit dynamic range for ambient light detection from 0 lx to about 120 klx with resolution down to 0.0036 lx/ct, supports low transmittance (dark) lens design
- 100 Hz and 120 Hz flicker noise rejection
- Excellent temperature compensation
- · High dynamic detection resolution
- · Software shutdown mode control

PRODUCT SUMMARY													
	PART NUMBER	OPERATING RANGE (mm)	OPERATING VOLTAGE RANGE (V)	I ² C BUS VOLTAGE RANGE (V)	AMBIENT LIGHT RANGE (lx)	AMBIENT LIGHT RESOLUTION (lx)	OUTPUT CODE	ADC RESOLUTION PROXIMITY / AMBIENT LIGHT					
	VEML6030	n/a	2.5 to 3.6	1.7 to 3.6	0 to 120 000	0.0036	16 bit, I ² C	- / 0.0036					

ORDERING INFORMATION				
ORDERING CODE	PACKAGING	VOLUME (1)	REMARKS	
VEML6030	Tape and reel	MOQ: 3000	2.0 mm x 2.0 mm x 0.87 mm	
VEML6030-GS15	rape and ree	MOQ: 10 000	2.0 11111	

Note

(1) MOQ: minimum order quantity



ABSOLUTE MAXIMUM I	RATINGS ($T_{amb} = 25 ^{\circ}\text{C}$, unless otherw	ise specifie	d)		
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT
Supply voltage		V_{DD}	0	4	V
Operation temperature range		T _{amb}	-25	+85	°C
Storage temperature range		T _{stg}	-25	+85	°C
Total power dissipation	T _{amb} ≤ 25 °C	P _{tot}	-	50	mW
Junction temperature		Tj	-	110	°C

BASIC CHARACTERISTI	ICS (T _{amb} = 25 °C, unless otherwise spe	ecified)				
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		V_{DD}	2.5	3.3	3.6	V
Shut down current (2)	V _{DD} is 3.3 V	I _{sd}	-	0.5	-	μΑ
	V_{DD} is 3.3 V, PSM = 11, refresh time 4100 ms	I _{DD}	-	2	-	μΑ
Operation mode current (1)	V_{DD} is 3.3 V, PSM = 00, refresh time 600 ms	I _{DD}	-	8	-	μΑ
	V _{DD} is 3.3 V, PSM_EN = 0, refresh time 100 ms	I _{DD}	-	45	-	μΑ
I ² C clock rate range		f _{SCL}	10	-	400	kHz
I ² C bus input H-level range	V _{DD} is 3.3 V	V_{ih}	1.3	-	3.6	V
I ² C bus input L-level range	V _{DD} is 3.3 V	V _{il}	-0.3	-	0.4	V
Digital current out (low, current sink)		l _{ol}	3	-	-	mA
Digital resolution (LSB count)	with ALS_GAIN = "01"		-	0.0036	-	lx/step
Detectable minimum illuminance	with ALS_GAIN = "01"	E _{V min.}	-	0.0072	-	lx
Detectable maximum illuminance	with ALS_GAIN = "10"	E _{V max.}	-	120 000	-	lx
Dark offset (2)	with ALS_GAIN = "01"		-	3	-	step

Notes

(1) Light source: white LED(2) Light conditions: dark

CIRCUIT BLOCK DIAGRAM

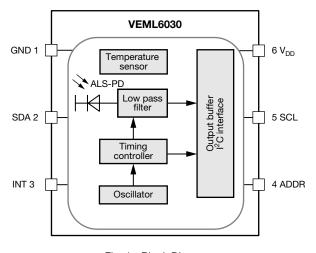


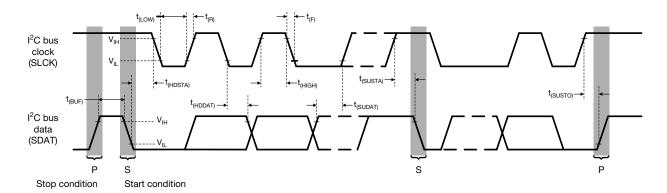
Fig. 1 - Block Diagram

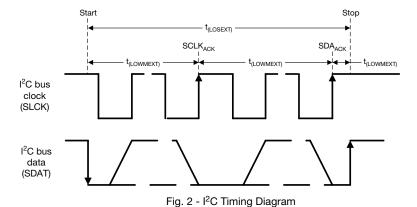


I ² C TIMING CHARACTERISTICS (T	_{amb} = 25 °C,	unless othe	rwise specifi	ed)		
PARAMETER	SYMBOL	STANDAR	D MODE (1)	FAST M	UNIT	
PANAIVIETEN	STIVIBOL	MIN.	MAX.	MIN.	MAX.	ONII
Clock frequency	f _(SMBCLK)	10	100	10	400	kHz
Bus free time between start and stop condition	t _(BUF)	4.7	-	1.3	-	μs
Hold time after (repeated) start condition; after this period, the first clock is generated	t _(HDSTA)	4.0	-	0.6	-	μs
Repeated start condition setup time	t _(SUSTA)	4.7	-	0.6	-	μs
Stop condition setup time	t _(SUSTO)	4.0	-	0.6	-	μs
Data hold time	t _(HDDAT)	0	3450	0	900	ns
Data setup time	t _(SUDAT)	250	-	100	-	ns
I ² C clock (SCK) low period	t _(LOW)	4.7	-	1.3	-	μs
I ² C clock (SCK) high period	t _(HIGH)	4.0	-	0.6	-	μs
Detect clock / data low timeout	t _(TIMEOUT)	25	35	-	-	ms
Clock / data fall time	t _(F)	-	300	-	300	ns
Clock / data rise time	t _(R)	-	1000	-	300	ns

Note

(1) Data based on standard I²C protocol requirement, not tested in production







PARAMETER TIMING INFORMATION

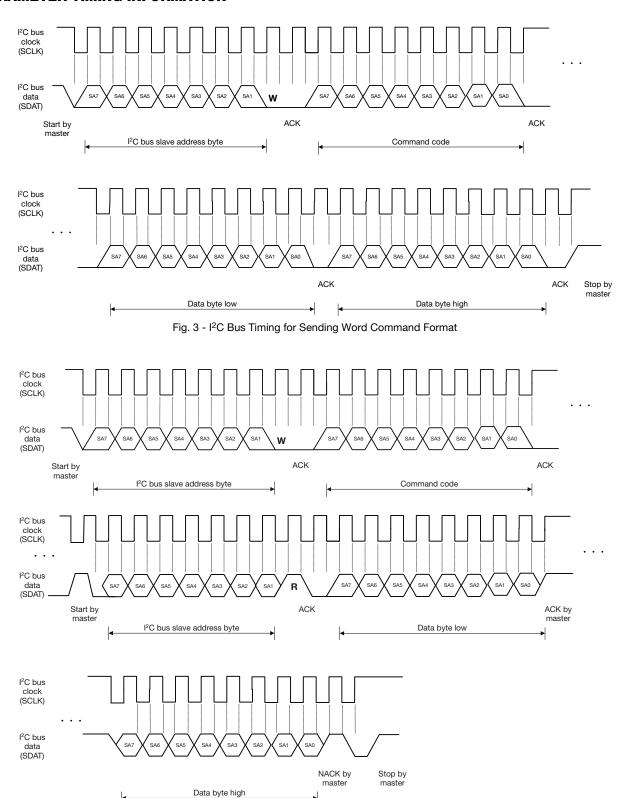


Fig. 4 - I²C Bus Timing for Receive Word Command Format

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

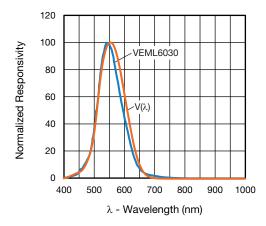


Fig. 5 - Spectral Response

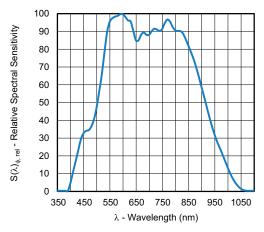


Fig. 6 - White Channel Responsivity

ALS sensitivity spectrum close to human eye photopic curve $V(\lambda)$. Human eye curve adaption achieved by Filtron technology.

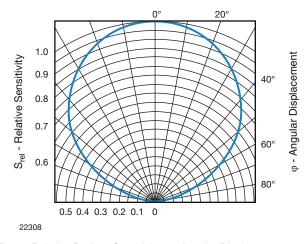


Fig. 7 - Relative Radiant Sensitivity vs. Angular Displacement

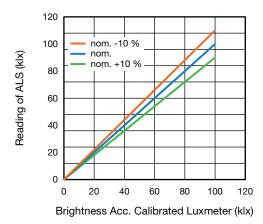


Fig. 8 - ALS measurement deviation between different light sources: \leq 10 $\,\%$



APPLICATION INFORMATION

VEML6030 is a cost effective solution of ambient light sensor with I²C bus interface. The standard serial digital interface is easy to access "Ambient Light Signal" without complex calculation and programming by external controller. Beside the digital output also a flexible programmable interrupt pin is available.

1. Application Circuit

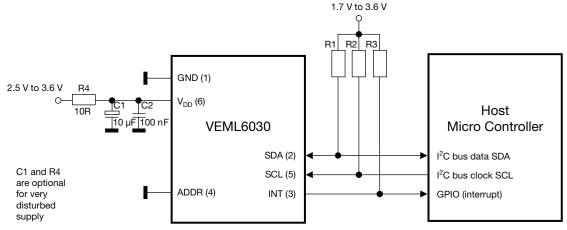


Fig. 9 - Application Circuit (x) = Pin Number

Notes

• The interrupt pin is an open drain output. Proposed values for the pull-up resistors should be > 1 k Ω , e.g. 2.2 k Ω to 4.7 k Ω for the R1 and R2 (at SDA and SCL) and 10 k Ω to 100 k Ω for R3 (at interrupt). Normally just one decoupling capacitor is needed. This should be \geq 100 nF and placed close to the V_{DD} pin.

Pin ADDR allows for the device addresses: pin 4 = high (V_{DD}) = 0x48, pin 4 = low (GND) = 0x10

For detailed description about set-up and use of the interrupt as well as more application related information see AN: "Designing VEML6030 into an Application"

2. I²C Interface

The VEML6030 contains actual six 16 bit command codes for operation control, parameter setup, and result buffering. All registers are accessible via I²C communication. Figure 7 shows the basic I²C communication with VEML6030.

The built in I²C interface is compatible with I²C modes "standard" and "fast": 10 kHz to 400 kHz.

 I^2C H-level range = 1.3 V to 3.6 V.

Please refer to the I²C specification from NXP for details.

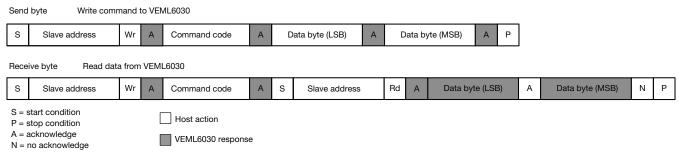


Fig. 10 - Send Byte / Receive Byte Protocol

Device Address

The VEML6030 has two fix slave addresses for the host programming and accessing selection.

With ADDR pin plugged to power supply = high = V_{DD} , the predefined 7 bit I2C bus address is set to 1001000 = 0x48. The least significant bit (LSB) defines read or write mode.

Accordingly the bus address is set to $1001\ 0000 = 90h$ for write and $1001\ 0001 = 91h$ for read.

With ADDR pin plugged to ground = low, the slave address (7 bit) is set to 0010000 = 0x10. According 8 bit the bus address is then 0010 0000 = 20h for write and 0010 0001 = 21h for read.



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Register Addresses

VEML6030 has actual six user accessible 16 bit command codes.

The addresses are 00h to 06h (03h not defined / reserved).

Auto-Memorization

VEML6030 can memorize the last ambient data before shutdown and keep this data before waking up.

When VEML6030 is in shutdown mode, the host can freely read this data via read command directly.

When VEML6030 wakes up, the data will be refreshed by new detection.

COMMAND REG	ISTER FORMAT			
COMMAND CODE	REGISTER NAME	BIT	FUNCTION / DESCRIPTION	R/W
00	ALS_CONF 0	15:0	ALS gain, integration time, interrupt, and shut down	W
01	ALS WH	15:8	ALS high threshold window setting (MSB)	W
01	ALS_WIT	7:0	ALS high threshold window setting (LSB)	W
02	ALS WL	15:8	ALS low threshold window setting (MSB)	W
02	ALS_VVL	7:0	ALS low threshold window setting (LSB)	W
03	Power saving	15:0	Set (15 : 3) 0000 0000 0000 0b	
04	ALS	15:8	MSB 8 bits data of whole ALS 16 bits	R
04	ALS	7:0	LSB 8 bits data of whole ALS 16 bits	R
05	WHITE	15:8	MSB 8 bits data of whole WHITE 16 bits	R
03	VVIIII	7:0	LSB 8 bits data of whole WHITE 16 bits	R
06	ALS_INT	15:0	ALS INT trigger event	R

Note

Command Code #0: Configuration Register

Register address = 00h

The command code #0 is for configuration of the ambient light measurements.

TABLE 1 - CONF	IGURATION REGI	STER #0	
REGISTER NAME	BIT	FUNCTION / DESCRIPTION	R/W
Reserved	15 : 13	Set 000b	W
ALS_GAIN	12 : 11	Gain selection 00 = ALS gain x 1 01 = ALS gain x 2 10 = ALS gain x (1/8) 11 = ALS gain x (1/4)	w
reserved	10	Set 0b	W
ALS_IT	9:6	ALS integration time setting 1100 = 25 ms 1000 = 50 ms 0000 = 100 ms 0001 = 200 ms 0010 = 400 ms 0011 = 800 ms	W
ALS_PERS	5:4	ALS persistence protect number setting $00 = 1$ $01 = 2$ $10 = 4$ $11 = 8$	w
Reserved	3:2	Set 00b	W
ALS_INT_EN	1	ALS interrupt enable setting 0 = ALS INT disable 1 = ALS INT enable	W
ALS_SD	0	ALS shut down setting 0 = ALS power on 1 = ALS shut down	W

Note

• Light level [lx] is (ALS OUTPUT DATA [dec.] / ALS Gain x responsivity). Please study also the application note

[•] Command code 0 default value is 01 = devices is shut down



Command Code #1: High Threshold Windows Setting

Command code address = 01h. Once enable INT function and use high / low windows threshold, bit 15:0 provides 16 bit register for high bound threshold windows setting.

TAB	TABLE 2 - HIGH THRESHOLD WINDOWS SETTING #1													
Bit 15 Bit 14 Bit 13 Bit 12 Bit 11 Bit 10 Bit 9 Bit 8 Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0												Bit 0		
	Description													
	ALS high threshold window setting (15:8 MSB 8 bits of whole 16 bits)													
ALS high threshold window setting (7:0 LSB 8 bits of whole 16 bits)														

Command Code #2: Low Threshold Windows Setting

Command code address = 02h. Once enable INT function and use high / low windows threshold, bit 15:0 provides 16 bit register for low bound threshold windows setting.

TABI	TABLE 3 - LOW THRESHOLD WINDOWS SETTING #2														
Bit 15	Bit 15 Bit 14 Bit 13 Bit 12 Bit 11 Bit 10 Bit 9 Bit 8 Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0												Bit 0		
							Desci	ription							
				ALS lov	thresho	ld windo	w setting	(15:8 MS	SB 8 bits	of whole	16 bits)				
	ALS low threshold window setting (7:0 LSB 8 bits of whole 16 bits)														

Command Code #3: Power Saving Mode: PSM

Command code address = 03h. Bits 2 and 1 define the power saving modes. Bits 15:3 are reserved.

TABLE 4 - POWER SAVING MODES												
COMMAND CODE	REGISTER NAME	BIT	FUNCTION / DESCRIPTION	R/W								
03	PSM	2:1	Power saving mode; see table "Refresh time" 00 = mode 1 01 = mode 2 10 = mode 3 11 = mode 4	w								
	PSM_EN	0	Power saving mode enable setting 0 = disable 1 = enable	W								

Command Code #4: ALS High Resolution Output Data

Command code address = 04h. To access 16 bit high resolution ALS output, it is suitable to follow read protocol to read from command code #04 16 bits register.

TABI	TABLE 5 - ALS HIGH RESOLUTION OUTPUT DATA #4														
Bit 15	Bit 15 Bit 14 Bit 13 Bit 12 Bit 11 Bit 10 Bit 9 Bit 8 Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0												Bit 0		
							Descr	ription							
	ALS high resolution output data (15 : 8 MSB 8 bits of whole 16 bits)														
	ALS high resolution output data (7 : 0 LSB 8 bits of whole 16 bits)														

Command Code #5: White Channel Output Data

Command code address = 05h. To access 16 bit WHITE output, it is suitable to follow read protocol to read from command code #05 16 bits register.

TAB	TABLE 6 - WHITE CHANNEL OUTPUT DATA #5														
Bit 15	Bit 15 Bit 14 Bit 13 Bit 12 Bit 11 Bit 10 Bit 9 Bit 8 Bit 7 Bit 6 Bit 5 Bit 4 Bit 3 Bit 2 Bit 1 Bit 0												Bit 0		
							Descr	ription							
	WHITE output data (15 : 8 MSB 8 bits of whole 16 bits)														
WHITE output data (7:0 LSB 8 bits of whole 16 bits)															



Command Code #6: Interrupt Status

Command code address = 06h. Bit 15 defines interrupt flag while trigger occurred due to data crossing low threshold windows. Bit 14 defines interrupt flag while trigger occurred due to data crossing high threshold windows.

TABLE 7 - INTERRUPT STATUS #6							
Bit 15	Bit 14	Bit 13 to 0					
int_th_low	int_th_high	reserved					
Description							
int_th_low		Read bit. Indicated a low threshold exceed					
int_th_high		Read bit. Indicated a high threshold exceed					

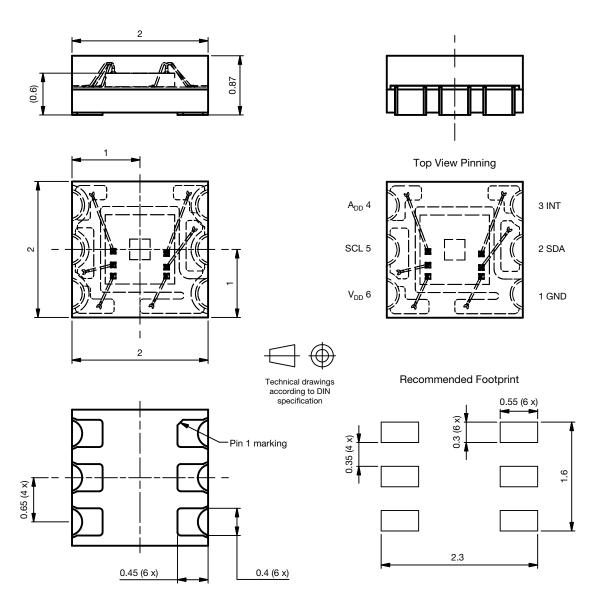
REFRESH TIME DETERMINATION OF PSM

VEML6030's refresh time can be determined by PSM and ALS_IT setting in power saving mode (PSM). Cooperating with the command register setting, the designer has a flexible method in defining the timing, power consumption, and sensitivity for light data collection.

REFRESH TIME, I _{DD} , AND RESOLUTION RELATION							
ALS_GAIN	PSM	ALS_IT	REFRESH TIME (ms)	I _{DD} (μA)	RESOLUTION (lx/bit)		
01	00	0000	600	8	0.0288		
01	01	0000	1100	5	0.0288		
01	10	0000	2100	3	0.0288		
01	11	0000	4100	2	0.0288		
01	00	0001	700	13	0.0144		
01	01	0001	1200	8	0.0144		
01	10	0001	2200	5	0.0144		
01	11	0001	4200	3	0.0144		
01	00	0010	900	20	0.0072		
01	01	0010	1400	13	0.0072		
01	10	0010	2400	8	0.0072		
01	11	0010	4400	5	0.0072		
01	00	0011	1300	28	0.0036		
01	01	0011	1800	20	0.0036		
01	10	0011	2800	13	0.0036		
01	11	0011	4800	8	0.0036		



PACKAGE DIMENSIONS in millimeters



Drawing No.: 6.550-5348.01-4

Issue: 1; 19.02.16 Not indicated tolerances \pm 0.1

TAPE AND REEL DIMENSIONS in millimeters

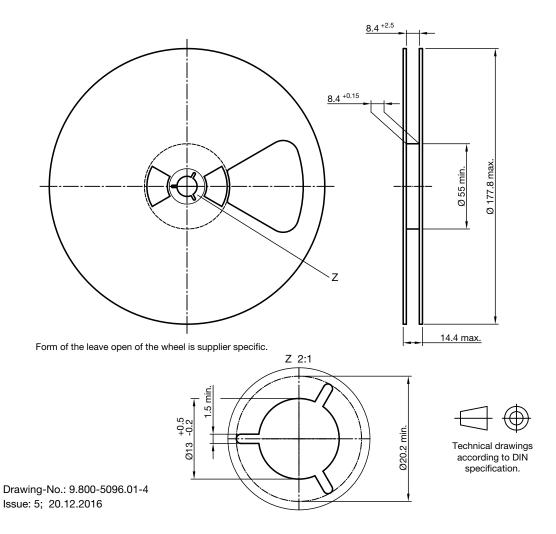
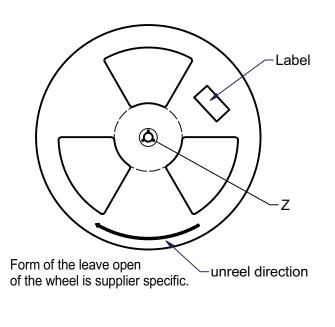
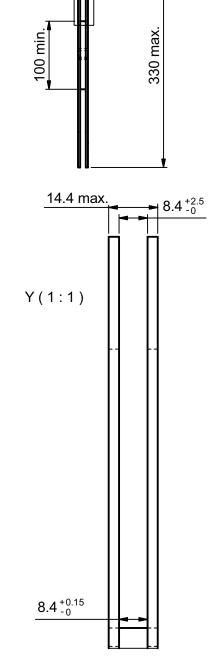
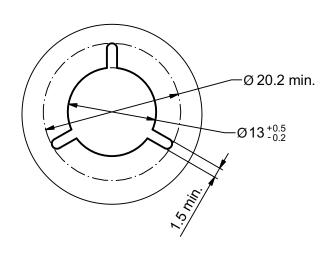


Fig. 11 - 7" Reel, 3000 Pieces





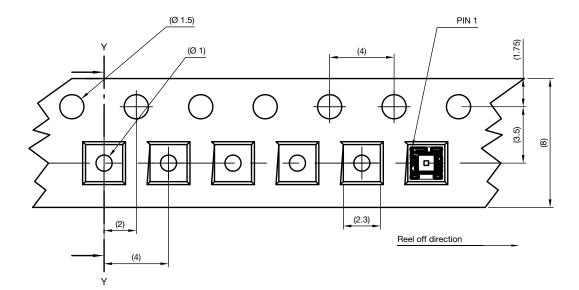


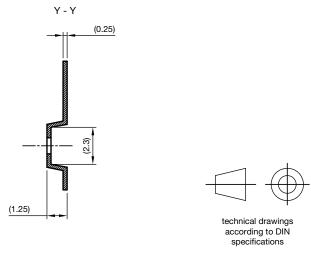


Drawing-No.: 9.800-5140.01-4 Issue: prel. 1; 02.03.2016

Technical drawings according to DIN specification.

Fig. 12 - 13" Reel, 10 000 Pieces





Drawing-No.: 9.700-5397.01-4 Issue: 1; 19.02.16

Fig. 13 - Taping

REFLOW SOLDER PROFILE

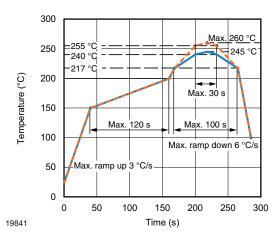


Fig. 14 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 72 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 4, according to J-STD-020.

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 $^{\circ}$ C (+ 5 $^{\circ}$ C), RH < 5 $^{\circ}$ M.



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